ETAS ID: TM368022

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: RELEASE OF SECURITY INTEREST

CONVEYING PARTY DATA

Name	Formerly	Execution Date	Entity Type	
MADISON CAPITAL FUNDING LLC		01/01/2016	LIMITED LIABILITY COMPANY: DELAWARE	

RECEIVING PARTY DATA

Name:	QUATECH, LLC
Street Address:	707 DAYTON ROAD
City:	OTTAWA
State/Country:	ILLINOIS
Postal Code:	61350
Entity Type:	LIMITED LIABILITY COMPANY: DELAWARE

PROPERTY NUMBERS Total: 3

Property Type	Number	Word Mark
Registration Number:	2958472	AIRBORNEDIRECT
Registration Number:	2978908	AIRBORNE
Registration Number:	2020456	QUATECH

CORRESPONDENCE DATA

Fax Number: 6508134848

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6508134800

Email: patents@dechert.com

Dechert LLP **Correspondent Name:**

2440 W. El Camino Real Address Line 1:

Address Line 2: Suite 700

Address Line 4: Mountain View, CALIFORNIA 94040

ATTORNEY DOCKET NUMBER:	380582-141546
NAME OF SUBMITTER:	Ryan R. Tooley
SIGNATURE:	/Ryan R. Tooley/
DATE SIGNED:	01/05/2016

Total Attachments: 3

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TRADEMARK
REEL: 005702 FRAME: 0948

RELEASE OF SECURITY INTEREST IN TRADEMARKS

THIS RELEASE OF SECURITY INTEREST IN TRADEMARKS ("Release") is

made as of this 1st day of January 2016, by MADISON CAPITAL FUNDING LLC, in its

capacity as agent ("Agent"), in favor of QUATECH, LLC (formerly known as Q-Tech

Acquisition, LLC), a Delaware limited liability company ("Company").

Reference is made to that certain Payoff Letter dated as of January 1, 2016 by and

among Agent, the Company and certain affiliates of the Company party thereto (the "Payoff

Letter").

FOR GOOD AND VALUABLE CONSIDERATION, the receipt and adequacy of

which are hereby acknowledged, subject to the terms and conditions of the Payoff Letter, Agent

hereby releases its liens on and security interests in the trademarks listed on Schedule A attached

hereto and made a part hereof, which liens and security interests were established under and

pursuant to that certain Trademark Security Agreement dated October 12, 2011 executed by

Company in favor of Agent and recorded with the United States Patent and Trademark Office on

October 13, 2011 at Reel/Frame 4641/0199.

[Signature Page Follows]

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TRADEMARK REEL: 005702 FRAME: 0949 IN WITNESS HEREOF, Agent has caused this Release to be duly executed by its duly authorized officer as of the day and year first above written.

MADISON CAPITAL FUNDING LLC, as Agent

Name: Ayon Reho

Title: Vice Assident

Trademark Release Quatech

TRADEMARK
REEL: 005702 FRAME: 0950

SCHEDULE A

TRADEMARK REGISTRATIONS

Trademark	Application	Application	Registration	Registration	Jurisdiction
	Number	Date	Number	Date	of Registration
AIRBORNEDIRECT	78304711	September 24, 2003	2958472	May 31, 2005	U.S.
AIRBORNE	78259260	June 6, 2003	2978908	July 26, 2005	U.S.
QUATECH	74724366	September 1, 1995	2020456	December 3, 1996	U.S.

TRADEMARK REEL: 005702 FRAME: 0951

RECORDED: 01/05/2016